

## C1210X279DATACTU

Aliases (C1210X279DATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 2.7 pF, +/-0.5 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



Click here for the 3D model.

| General Information      |  |  |
|--------------------------|--|--|
| Series                   | SMD Comm X8G HT150C Flex                     |  |
| Style                    | SMD Chip                                     |  |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |  |
| Features                 | High Temperature, Ultra-Stable               |  |
| RoHS                     | Yes  |  |
| Termination              | Flexible Termination                         |  |
| Marking                  | No   |  |
| AEC-Q200                 | No   |  |
| Typical Component Weight | 30 mg  |  |
| Shelf Life               | 78 Weeks                                     |  |
| MSL                      | 1  |  |

|                          | Specifications   |  |
|--------------------------|--|--|
| 1210                     | Capacitance  | 2.7 pF   |
| 3.3mm +/-0.4mm           | Measurement Condition  | 1 MHz 1.0Vrms                                      |
| 2.6mm +/-0.3mm           | Tolerance  | +/-0.5 pF  |
| 0.78mm +/-0.20mm         | Voltage DC   | 250 VDC  |
| 1.5mm MIN                | Dielectric Withstanding Voltage  | 625 VDC  |
| 0.6mm +/-0.25mm          | Temperature Range  | -55/+150°C   |
|                          | Temp. Coefficient  | X8G  |
| T&R, 180mm, Plastic Tape | Capacitance Change with<br>Reference to +25°C and 0 VDC<br>Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms                          |
| 4000                     | Dissipation Factor   | 0.1% 1 MHz 1.0Vrms                                 |
|                          | Aging Rate   | 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |

100 GOhms

Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions

**Packaging Specifications** 

Packaging Quantity

Chip Size

L W

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Packaging